

## LOW CAPACITANCE TVS ARRAY

### APPLICATIONS

- ✓ Wireless Communication Circuits
- ✓ RS-422, RS-432 & RS-485
- ✓ Low Voltage ASICs
- ✓ Ethernet - 10/100 Base T

### IEC COMPATIBILITY (EN61000-4)

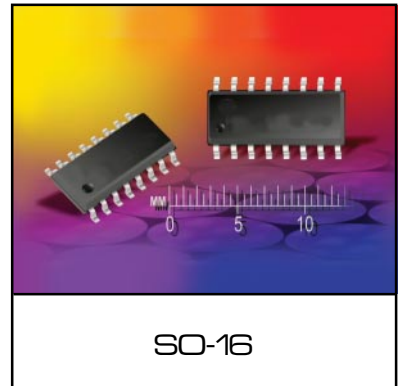
- ✓ 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
- ✓ 61000-4-4 (EFT): 40A - 5/50ns
- ✓ 61000-4-5 (Surge): 12A, 8/20 $\mu$ s Level 1 (Line-Ground) & Level 2 (Line-Line)

### FEATURES

- ✓ 500 Watts Peak Pulse Power per Line (tp=8/20 $\mu$ s)
- ✓ Unidirectional & Bidirectional Configuration
- ✓ ESD Protection > 40 kilovolts
- ✓ Available in Multiple Voltage Types: 3.3V to 36V
- ✓ Protects Up to Eight (8) Lines
- ✓ **LOW CAPACITANCE: 15pF**
- ✓ RoHS Compliant in Lead-Free Versions

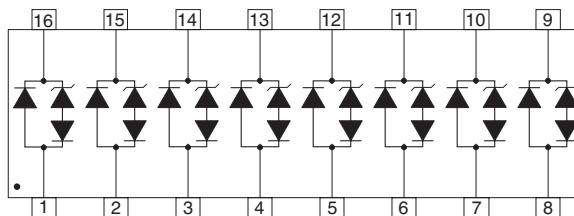
### MECHANICAL CHARACTERISTICS

- ✓ Molded JEDEC SO-16 Package
- ✓ Weight 0.15 grams (Approximate)
- ✓ Available in Tin-Lead or Lead-Free Pure-Tin Plating(Annealed)
- ✓ Solder Reflow Temperature:
  - Tin-Lead - Sn/Pb, 85/15: 240-245°C
  - Pure-Tin - Sn, 100: 260-270°C
- ✓ Flammability rating UL 94V-0
- ✓ 16mm Tape and Reel Per EIA Standard 481
- ✓ Marking: Logo, Part Number, Date Code & Pin One Defined By Dot on Top of Package

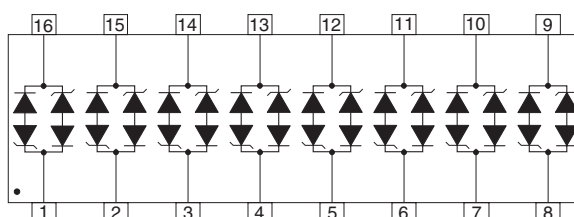


### PIN CONFIGURATIONS

#### UNIDIRECTIONAL CONFIGURATION



#### BIDIRECTIONAL CONFIGURATION



# SM16LC03 thru SM16LC36C

## DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified			
PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power ( $t_p = 8/20\mu s$ ) - See Figure 1	$P_{PP}$	500	Watts
Operating Temperature	$T_J$	-55°C to 150°C	°C
Storage Temperature	$T_{STG}$	-55°C to 150°C	°C
Forward Voltage @ 50mA, 300 $\mu s$ - Square Wave (Note 1)	$V_F$	1.5	Volts
Soldering Temperature for 10 seconds	$T_L$	265	°C

**Note 1:** Only applies to unidirectional devices.

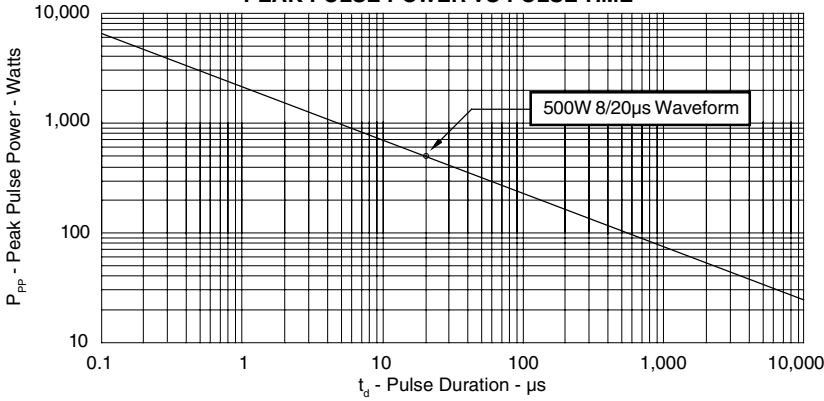
ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified							
PART NUMBER (Notes 1 & 2)	RATED STAND-OFF VOLTAGE  $V_{WM}$ VOLTS	MINIMUM BREAKDOWN VOLTAGE	MAXIMUM CLAMPING VOLTAGE (See Fig. 2)	MAXIMUM CLAMPING VOLTAGE (See Fig. 2)	MAXIMUM LEAKAGE CURRENT	MAXIMUM CAPACITANCE	TEMPERATURE COEFFICIENT OF $V_{(BR)}$
		@ 1mA $V_{(BR)}$ VOLTS	@ $I_p = 1 A$ $V_C$ VOLTS	@ 8/20 $\mu s$ $V_C @ I_{PP}$	@ $V_{WM}$ $I_D$ $\mu A$	@ 0V, 1 MHz C pF	$\theta V_{(BR)}$ mV/°C
SM16LC03	3.3	4.5	7.0	20.0V @ 35A	125	15	-3
SM16LC03C	3.3	4.5	7.0	20.0V @ 35A	125	15	-3
SM16LC05	5.0	6.0	9.8	24.0V @ 42A	20	15	3
SM16LC05C	5.0	6.0	9.8	24.0V @ 42A	20	15	3
SM16LC08	8.0	8.5	13.4	26.0V @ 30A	10	15	9
SM16LC08C	8.0	8.5	13.4	26.0V @ 30A	10	15	9
SM16LC12	12.0	13.3	19.0	33.0V @ 21A	2	15	16
SM16LC12C	12.0	13.3	19.0	33.0V @ 21A	2	15	16
SM16LC15	15.0	16.7	25.5	39.0V @ 15A	2	15	17
SM16LC15C	15.0	16.7	25.5	39.0V @ 15A	2	15	17
SM16LC24	24.0	26.7	40.0	57.0V @ 10A	2	15	26
SM16LC24C	24.0	26.7	40.0	57.0V @ 10A	2	15	26
SM16LC36	36.0	40.0	53.0	72.0V @ 7.0A	2	15	36
SM16LC36C	36.0	40.0	53.0	72.0V @ 7.0A	2	15	36

**Note 1:** Part numbers with a "C" suffix are bidirectional devices, i.e., SM16LC05C.

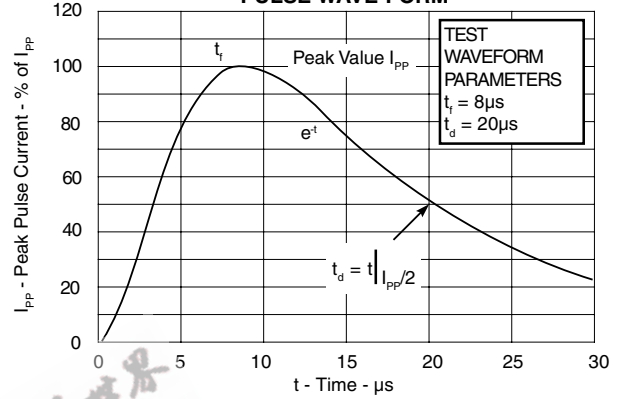
**Note 2:** *Unidirectional Devices Only:* Do not surge from pins 16 to 1, 15 to 2, 14 to 3, 13 to 4, 12 to 5, 11 to 6, 10 to 7 and 9 to 8. PIV typically greater than 100V for each rectifier diode.

## GRAPHS

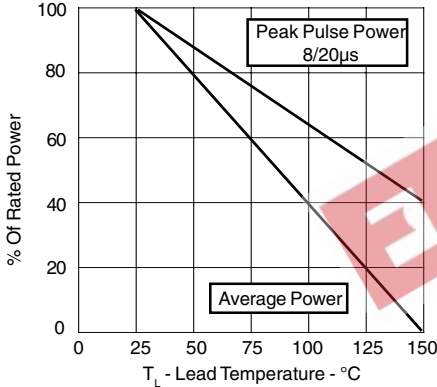
**FIGURE 1  
PEAK PULSE POWER VS PULSE TIME**



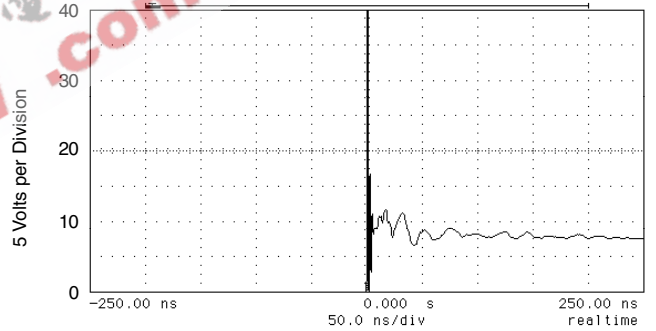
**FIGURE 2  
PULSE WAVE FORM**



**FIGURE 3  
POWER DERATING CURVE**

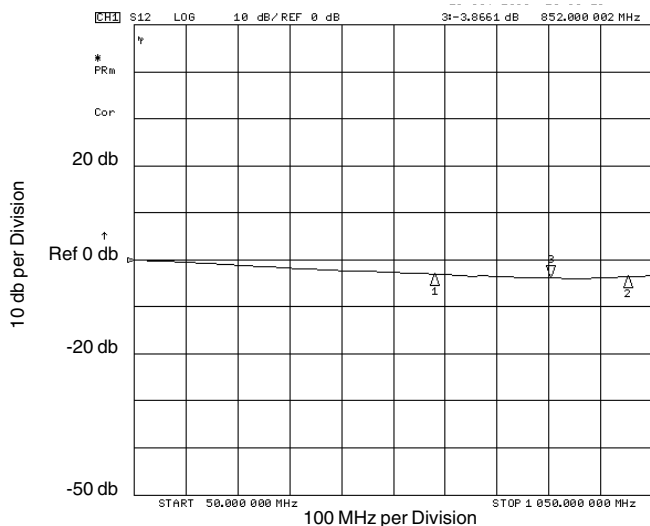


**FIGURE 4  
OVERSHOOT & CLAMPING VOLTAGE FOR SM16LC05**

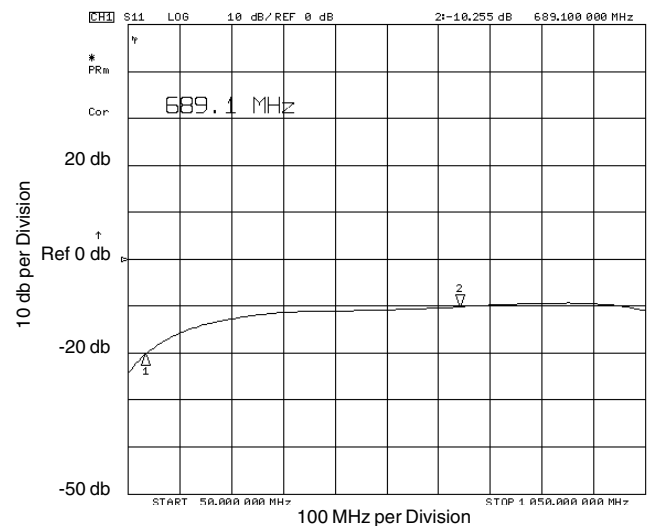


ESD Test Pulse: 25 kilovolt, 1/30ns (waveform)

**FIGURE 5  
INSERTION LOSS - SM16LC12**



**FIGURE 6  
RETURN LOSS - SM16LC12**



## APPLICATION NOTE

The SM16LC & SM16LCxxC Series are TVS arrays designed to protect I/O or data lines from the damaging effects of ESD, EFT and other types of surges. This product series provides both unidirectional and bidirectional protection, with a surge capability of 500 Watts  $P_{pp}$  per line for an 8/20 $\mu$ s waveform and ESD protection > 40kV.

### BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 1)

Ideal for RS-485 applications, the SM16LCxxC Series provides up to eight (8) lines of protection in a common-mode configuration as depicted in Figure 1. This low capacitance series allows the transceiver or telecommunications circuit to operate safely without significant signal distortion.

Circuit connectivity is as follows:

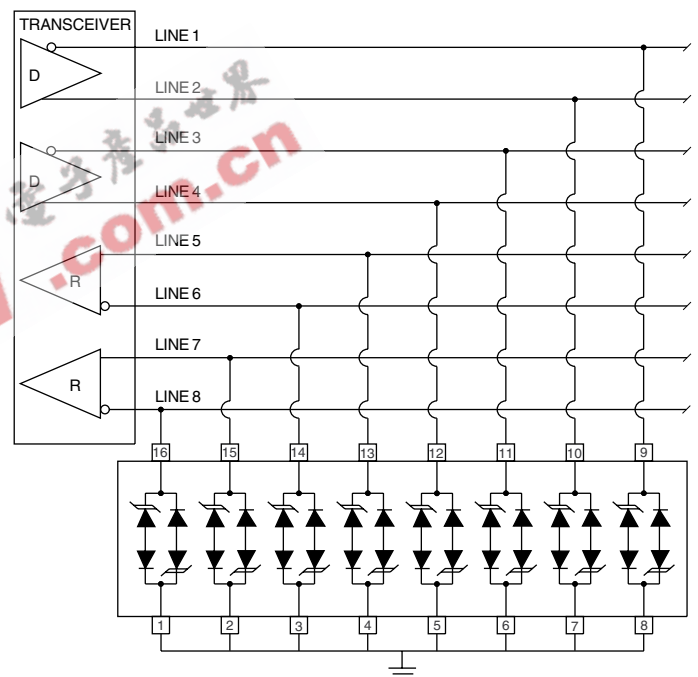
- ✓ Lines 1 is connected to Pin 9.
- ✓ Line 2 is connected to Pin 10.
- ✓ Line 3 is connected to Pin 11.
- ✓ Line 4 is connected to Pin 12.
- ✓ Line 5 is connected to Pin 13.
- ✓ Line 6 is connected to Pin 14.
- ✓ Line 7 is connected to Pin 15.
- ✓ Line 8 is connected to Pin 16.
- ✓ Pins 1-8 are connected to ground.

### CIRCUIT BOARD LAYOUT RECOMMENDATIONS

Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- ✓ The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- ✓ The path length between the TVS device and the protected line should be minimized.
- ✓ All conductive loops including power and ground loops should be minimized.
- ✓ The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- ✓ Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

Figure 1. Bidirectional Common-Mode Protection



# SM16LC03 thru SM16LC36C

## PACKAGE OUTLINE & DIMENSIONS

### PACKAGE OUTLINE

**MOUNTING PAD**

### SO-16

### PACKAGE DIMENSIONS

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	9.80	10.00	0.386	0.393
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC	1.27 BSC	0.05 BSC	0.05 BSC
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

**NOTES**

- T - = Seating Plane and Datum Surface.
- Dimensions "A" and "B" are Datum.
- Dimensions "A" and "B" do not include mold protrusions.
- Maximum mold protrusion is 0.015" (0.380 mm) per side.
- Dimensioning and tolerances per ANSI Y14.5M, 1982.
- Dimensions are exclusive of mold flash and metal burrs.

**TAPE & REEL/BULK ORDERING NOMENCLATURE**

- Surface mount product is taped and reeled in accordance with EIA-481.
- Suffix-T7 = 7 Inch Reel - 1,000 pieces per 16mm tape, i.e., SM16LC05-T7.
- Suffix-T13 = 13 Inch Reel - 2,500 pieces per 16mm tape, i.e., SM16LC05-T13.
- Suffix - LF = Lead-Free, Pure-Tin Plating, i.e., SM16LC05C-LF-T7.
- No Suffix = Product Shipped in Tubes of 48 pcs per Tube.

**Outline & Dimensions: Rev 1 - 11/01, 06007**

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